

Features

- Integrated 6 fast recovery power MOSFETs (600V/3A)
- Integrated high voltage gate drive circuit
- Compatible with 3.3V&5V input signal, effective at high level
- Integrated temperature output
- Built-in quick recovery bootstrap diode
- Insulation class 1500Vrms / min
- Integrated bootstrap functionality
- High reliability and thermal stability, good parameter consistency



DIP-23



SOP-23

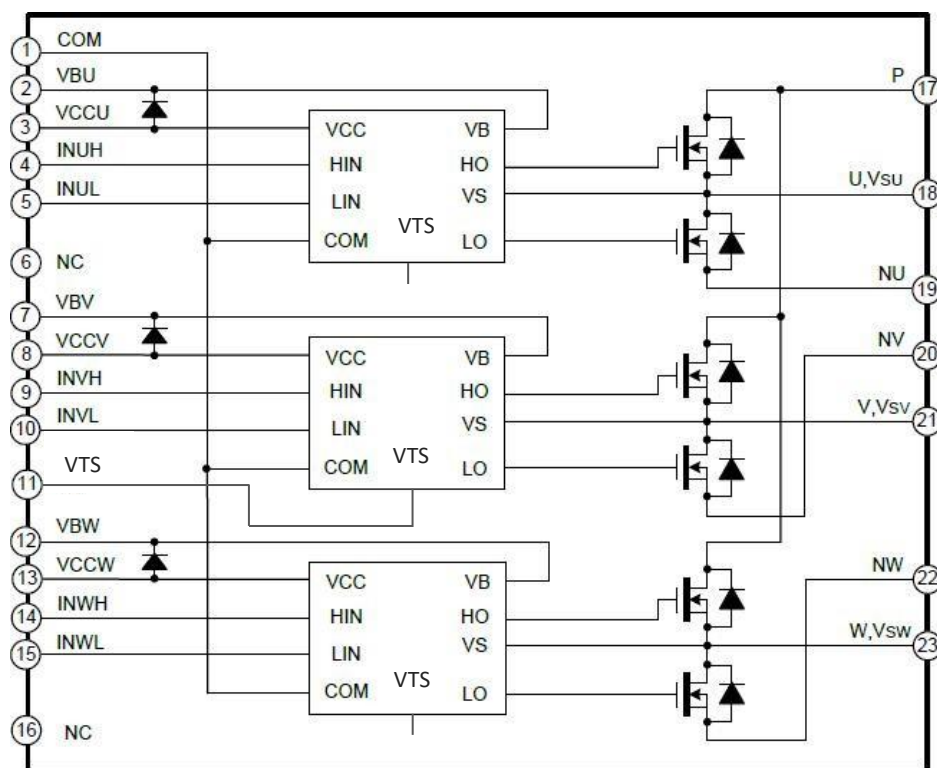
Applications

- Frequency converter
- Air Conditioning compressor
- Air cleaner
- Dish washer
- Cooker hood

Ordering Information

Product Name	Marking	Package Type
SYIM03M60ATD	SYIM03M60ATD	SOP-23H
SYIM03M60ATA	SYIM03M60ATA	DIP-23H

Internal Electrical Schematic



Absolute Maximum Ratings: $T_J = 25^{\circ}\text{C}$, unless otherwise noted

Parameter	Symbol	Value	Unit
DC link supply voltage of P- N	V_{PN}	600	V
Single MOSFET output current , $T_C=25^{\circ}\text{C}$	I_{D25}	3.0	A
Single MOSFET output current , $T_C=80^{\circ}\text{C}$	I_{D80}	2.5	
Single MOSFET peak output current $T_C=25^{\circ}\text{C}$, pulse width < 100 μs	I_{DP}	5.0	A
Power dissipation per MOSFET, $T_C=25^{\circ}\text{C}$	P_D	14	W
Module supply voltage	V_{CC}	25	V
High side floating supply voltage (V_B reference to V_S)	V_{BS}	20	V
Input voltage	V_{IN}	-0.3~ $V_{CC}+0.3$	V
Operating junction temperature	T_J	-55 to 150	$^{\circ}\text{C}$
Operating case temperature, $T_J \leq 150^{\circ}\text{C}$	T_C	-55 to 125	$^{\circ}\text{C}$
Storage temperature range	T_{STG}	-55 to 125	$^{\circ}\text{C}$
Single MOSFET thermal resistance, junction- case	$R_{\theta JC}$	9	$^{\circ}\text{C/W}$
Isolation test voltage (1min, RMS, f = 60Hz)	V_{ISO}	1500	Vrms
Bootstrap diode forward Voltage , $T_C=25^{\circ}\text{C}$	I_F	1	A
Bootstrap diode peak forward current , $T_C=25^{\circ}\text{C}$, pulse width =1ms	I_{FP}	3	A

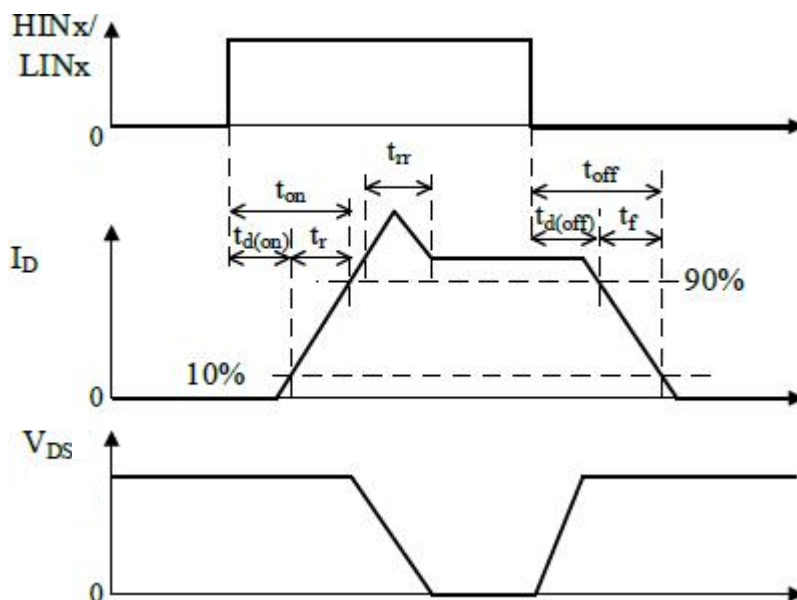
Recommended Operation Conditions

Parameter	Symbol	Value			Unit
		Min.	Typ.	Max.	
DC link supply voltage of P-N	V_{PN}	-	300	400	V
Low side supply voltage	V_{CC}	13.5	15	16.5	V
High side floating supply voltage	V_{BS}	13.5	15	16.5	V
Logic "1" input voltage (LIN, HIN)	$V_{IN(ON)}$	2.5	-	-	V
Logic "0" input voltage (LIN, HIN)	$V_{IN(OFF)}$	-	-	0.8	V
External deadtime between HIN and LIN	T_{dead}	-	540	-	ns
PWM switching frequency, $T_J \leq 150^{\circ}\text{C}$	f_{PWM}	-	16	-	KHz

Electrical Characteristics (unless otherwise noted, $T_J=25^{\circ}\text{C}$, $V_{CC}=V_{BS}=15\text{V}$)

Inverter section

Parameter	Symbol	Condition	Value			Unit
			Min.	Typ.	Max.	
Drain-Source blocking voltage	B_{VDSS}	$V_{IN}=0\text{V}$, $I_D=50\mu\text{A}$	-	600	-	V
Drain-Source leakage current	I_{DSS}	$V_{DS}=600\text{V}$, $V_{GS}=0\text{V}$	-	-	1	μA
Drain-Source on-state resistance	$R_{DS(on)}$	$V_{GS}=10\text{V}$, $I_D=3.0\text{A}$	-	2.5	-	Ω
Diode forward voltage	V_{SD}	$V_{SG}=0\text{V}$, $I_S=3.0\text{A}$	-	0.9	-	V
Switching time	t_{ON}	$V_{PN}=300\text{V}$, $V_{CC}=V_{BS}=15\text{V}$ $I_D=3.0\text{A}$, $V_{IN}=0\text{V}\sim 5\text{V}$, Inductive load	-	1080	-	ns
	t_{OFF}		-	680	-	ns
	t_{tr}		-	88	-	ns
	E_{ON}		-	76	-	μJ
	E_{OFF}		-	10	-	μJ



Switching Time Definition

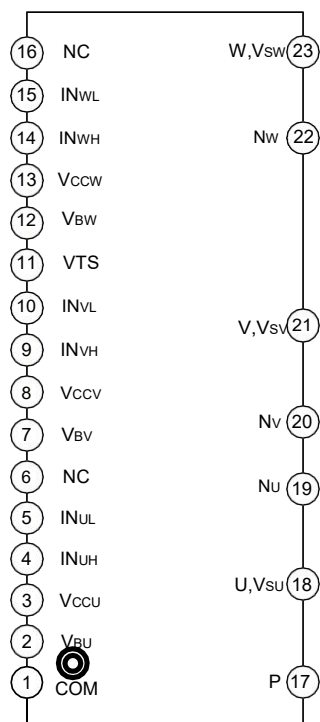
Control section

Parameter	Symbol	Condition		Value			Unit
				Min.	Typ.	Max.	
Quiescent V _{CC} supply current	I _{QCC}	VBIAS (V _{CC} , V _{BS}) =15V T _A =25°C		-	130	-	uA
Quiescent V _{BS} supply current	I _{QBS}			-	86	-	uA
Temperature Output	VTS	V phase HVIC temperature @25°C		780	890	980	mV
		V phase HVIC temperature @100°C		2.0	2.25	2.5	V
Low side undervoltage protection	UV _{CCR}	Reset level		8.4	8.9	9.0	V
High side undervoltage protection	UV _{BSR}	Reset level		8.7	8.9	9.1	V
Logic "1" input voltage (LIN, HIN)	V _{IH}	Logic high level	Between input and COM	2.3	-	-	V
Logic "0" input voltage (LIN, HIN)	V _{IL}	Logic Low level		-	-	1.4	V
Input bias current for LIN, HIN	I _{IH}	V _{IN} =5V	Between input and COM	-	13	-	uA
	I _{IL}	V _{IN} =0V		-	-	1	

Bootstrap diode section

Parameter	Symbol	Condition	Value			Unit
			Min.	Typ.	Max.	
Forward voltage	V_F	$I_F=1A @ T_J = 25^\circ C$	-	3.0	3.5	V
		$I_F=1A @ T_J = 125^\circ C$	-	-	3.0	
Reverse recovery time	t_{rr}	$I_F=1A, V_R=30V,$ $di_F/dt=-200A/\mu s$	-	-	45	ns

Pin Assignment



Pin Description

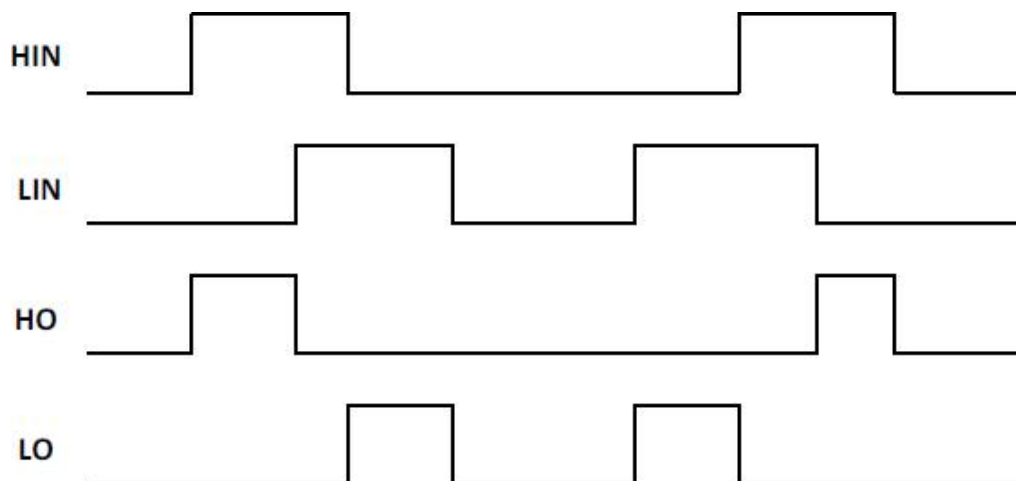
Pin Number	Pin Name	I/O	Pin Description
1	COM	I/O	Module common ground
2	V _{BU}	I/O	U-phase high side floating IC supply voltage
3	V _{CCU}	I/O	U-phase low side driver supply voltage
4	IN _{UH}	I	U-phase high side gate driver input
5	IN _{UL}	I	U-phase low side gate driver input
6	NC	I/O	No Connection
7	V _{BV}	I/O	V-phase high side floating IC supply voltage
8	V _{CCV}	I/O	V-phase low side driver supply voltage
9	IN _{VH}	I	V-phase high side gate driver input
10	IN _{VL}	I	V-phase low side gate driver input
11	VTS	O	Temperature sensing output signal
12	V _{BW}	I/O	W-phase high side floating IC supply voltage
13	V _{CCW}	I/O	W-phase low side driver supply voltage
14	IN _{WH}	I	W-phase high side gate driver input
15	IN _{WL}	I	W-phase low side gate driver input
16	NC	I/O	No Connection
17	P	I/O	Positive bus input voltage
18	U, V _{SU}	O	Motor U-phase output and U-phase high side drive bias voltage ground
19	N _U	I/O	U-phase low side source

Pin Number	Pin Name	I/O	Pin Description
20	N _V	I/O	V-phase low side source
21	V,V _{SV}	O	Motor V-phase output and V-phase high side drive bias voltage ground
22	N _W	I/O	W-phase low side source
23	W,V _{SW}	O	Motor W-phase output and W-phase high side drive bias voltage ground

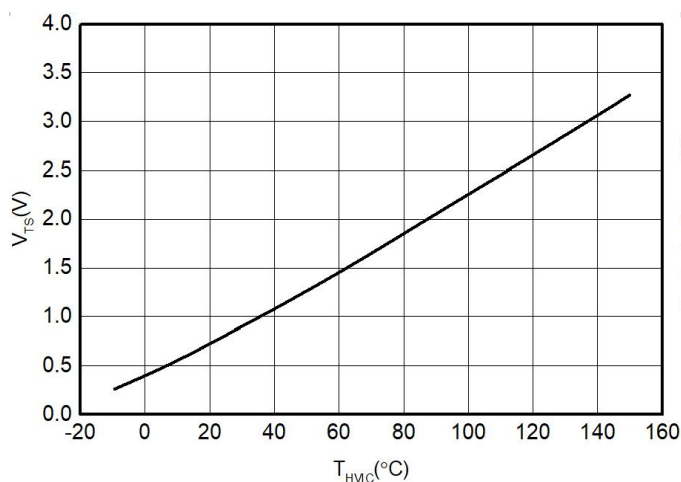
Function description

Input-output table

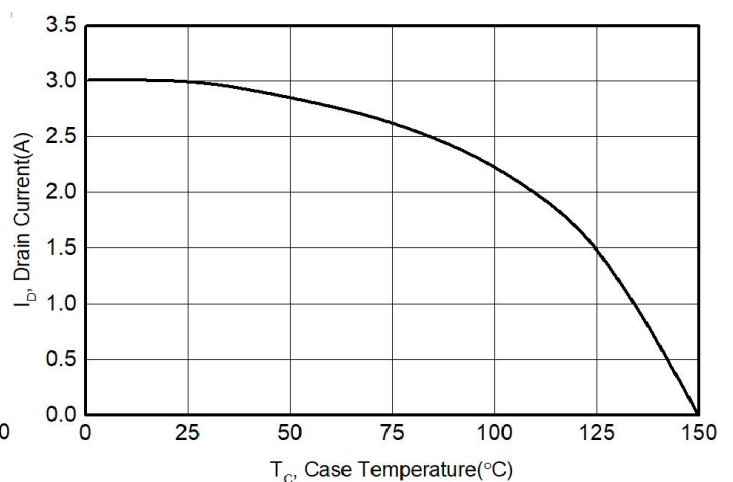
IN _H	IN _L	OUTPUT	Remark
0	0	Z	The high and low sides of the bridge arm are closed
0	1	0	The low side of the bridge arm is opened
1	0	VDC	The high side of the bridge arm is opened
1	1	Forbid	Bridge arm punch through
Open	Open	Z	The high and low sides of the bridge arm are closed



Control sequence diagram

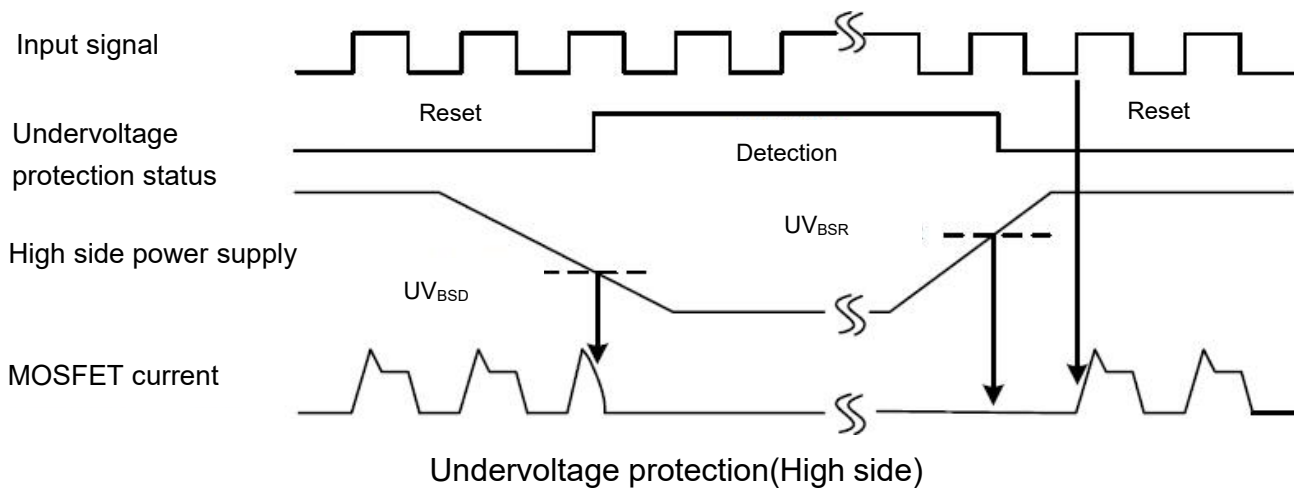
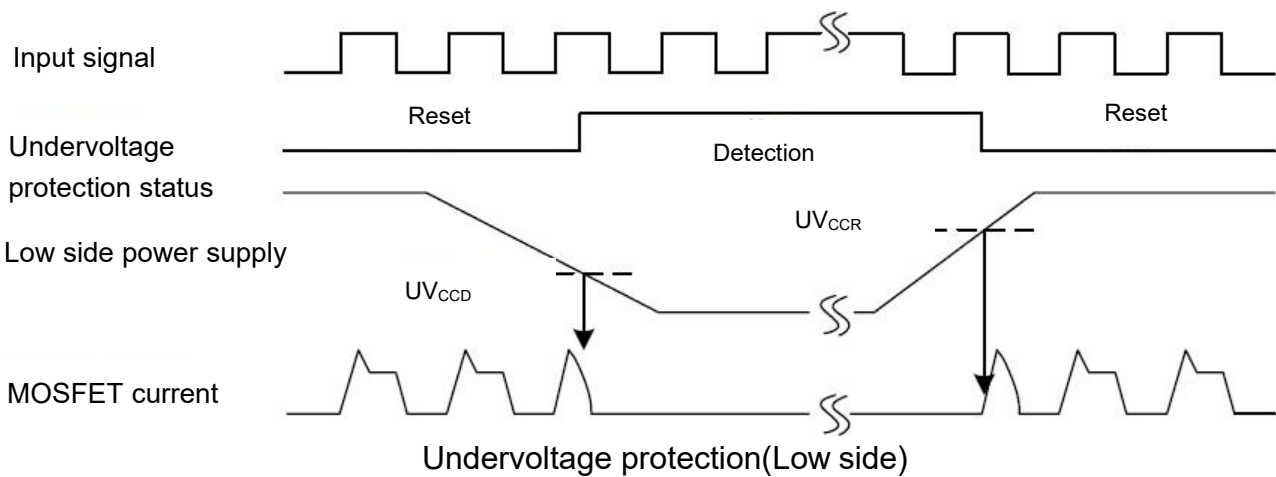
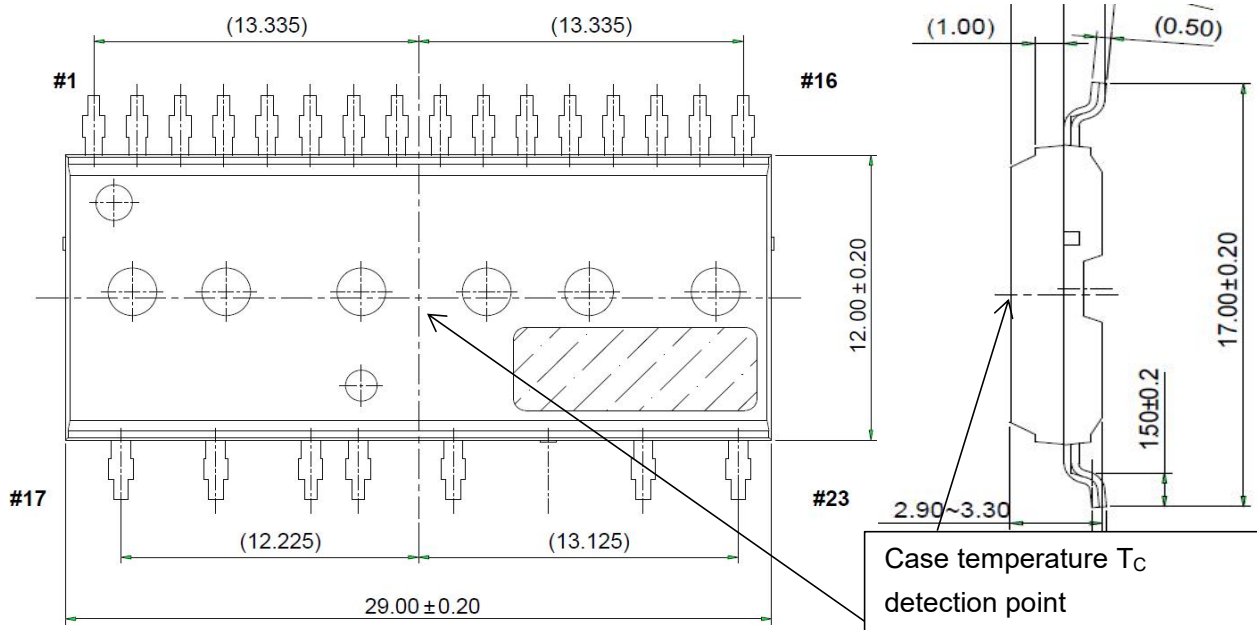


Temperature Profile of V_{TS}(Typical)

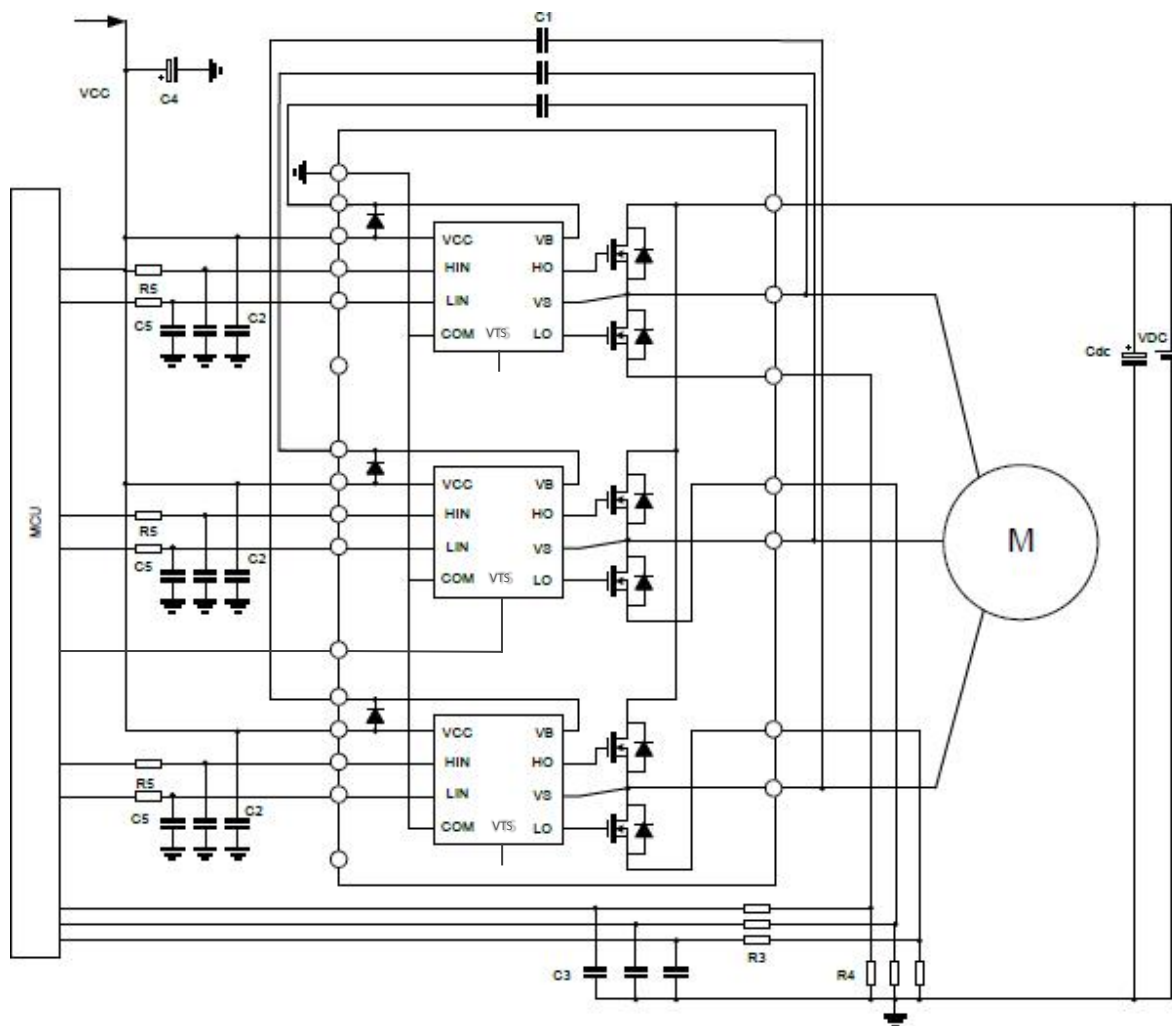


I_D Drain Current vs. Case Temperature

Case temperature T_c detection



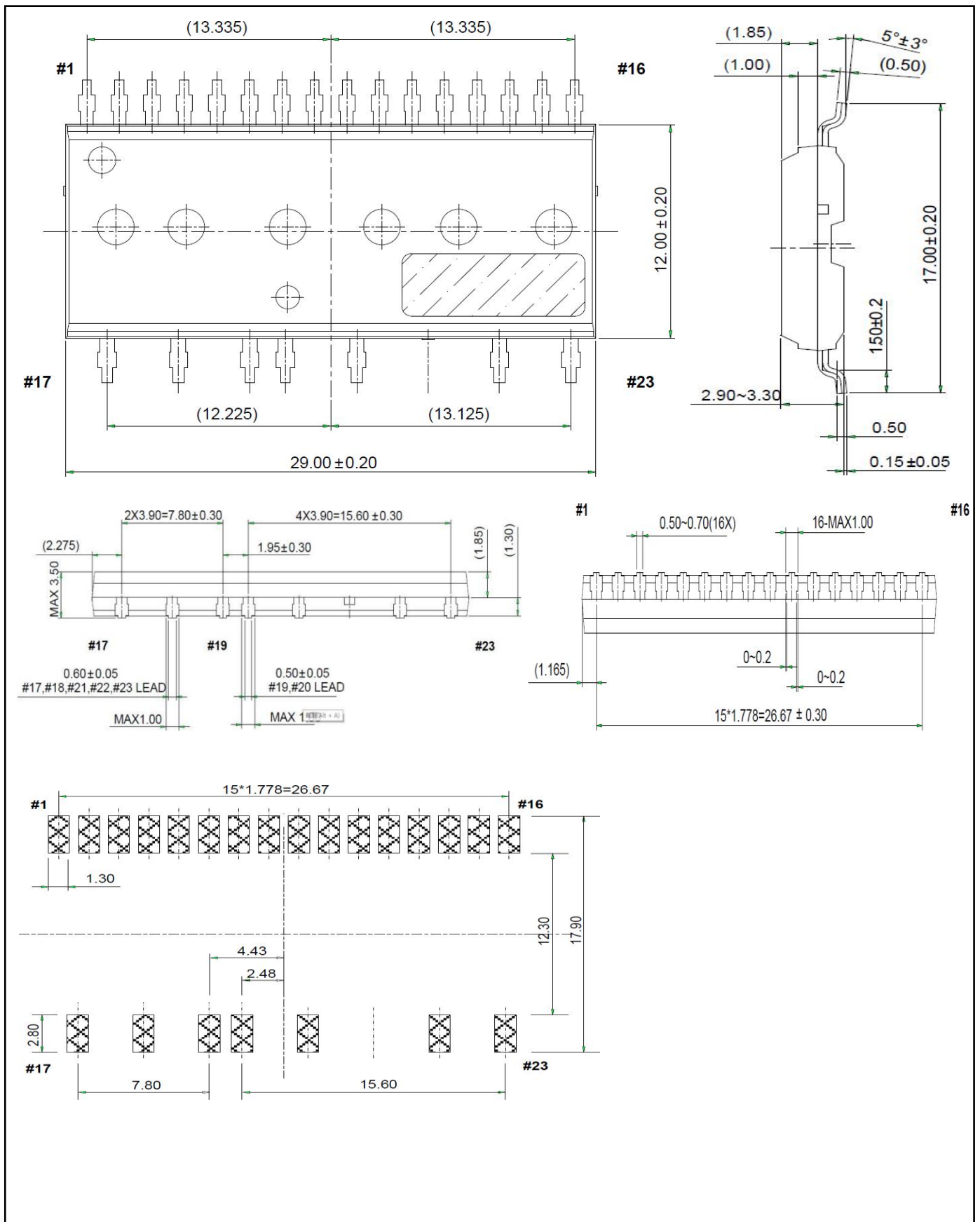
Typical Application Schematic:



Remark:

- (1) The wiring of each input pin shall be as short as possible, otherwise it may cause mis operation; in addition, RC filter can be used to reduce input signal noise.
- (2) All external capacitors should be located close to IPM.
- (3) In order to prevent surge damage, in addition to filter capacitance between PN, it is recommended to add a high-frequency non inductive smoothing capacitance, and the connection of capacitance should be as short as possible.
- (4) The filter capacitance at the input of VCC power supply is recommended to be at least 7 times of bootstrap capacitance C1.
- (5) The bootstrap capacitor C1 is suggested to adopt a capacitor with high frequency characteristics to absorb high frequency ripple current, and its capacitance value is suggested to be greater than 2.2uf.
- (6) The connection between current limiting resistor R4 and IPM shall be as short as possible to prevent the large surge voltage generated by the connection inductance from damaging IPM.

Package Outline SOP-23H



Package Outline DIP-23H

